# FP1007

# High frequency, high current power inductors



#### **Product description**

- · High current carrying capacity
- · Low core loss
- Frequency range up to 2MHz
- Inductance Range from 115 nH to 300nH
- Current range from 32 to 94 amps
- 10.4 x 8.0mm footprint surface mount package in 6.5, 7.0 or 7.5mm height
- Ferrite core material
- Halogen free, lead free, RoHS compliant

#### **Applications**

- Servers
- · Multi-phase and Vcore regulators
- Voltage Regulator Modules (VRMs)
- Desktop VRMs and EVRDs
- Data networking and storage systems
- Graphics cards and battery power systems
- Point-of-Load modules
- · DCR Sensing circuits

#### **Environmental data**

- Storage temperature range (Component): -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient + self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant









#### **Product specifications**

Part Number <sup>7</sup>	OCL <sup>1</sup> (nH)±10%	FLL <sup>2</sup> (nH) minimum	I <sub>rms</sub> ³ (amps)	I <sub>sat</sub> 1 <sup>4</sup> (amps)	I <sub>sat</sub> 2 <sup>5</sup> (amps)	DCR (mΩ) @ 20°C ±5%	K-factor <sup>8</sup>
R1 version							
FP1007R1-R12-R	120	86	60	81	65	0.29 ± 10%	371
FP1007R1-R14-R	140	100	60	72	56	0.29 ± 10%	371
FP1007R1-R17-R	170	122	60	58	46	0.29 ± 10%	371
FP1007R1-R22-R	215	155	60	50	36	0.29 ± 10%	371
FP1007R1-R30-R	300	216	60	32	26	0.29 ± 10%	371
R2 version							
FP1007R2-R12-R	120	86	51	81	65	0.48 ± 8%	368
FP1007R2-R14-R	140	100	51	72	56	0.48 ± 8%	368
FP1007R2-R17-R	170	122	51	58	46	0.48 ± 8%	368
FP1007R2-R22-R	215	155	51	50	36	0.48 ± 8%	368
FP1007R2-R30-R	300	216	51	32	26	0.48 ± 8%	368
R3 version							
FP1007R3-R12-R	115	83	61	94	86	0.29 ± 5%	354
FP1007R3-R15-R	150	108	61	76	70	0.29 ± 5%	354
FP1007R3-R17-R	175	126	61	66	60	0.29 ± 5%	354
FP1007R3-R22-R	215	155	61	50	43	0.29 ± 5%	354
FP1007R3-R23-R	230	165	61	48	40	0.29 ± 5%	354
FP1007R3-R27-R	270	194	61	40	34	0.29 ± 5%	354
FP1007R3-R30-R	300	216	61	35	30	0.29 ± 5%	354

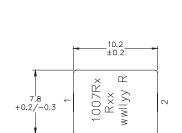
- 1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.1Vrms, 0.0Adc, +25°C
- 2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1Vrms, I<sub>sat</sub>1, +25°C
- 3. I<sub>ms</sub>: Irms: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.
- 4. I<sub>sat</sub>1: Peak current for approximately 20% rolloff @ +25°C
- 5. I<sub>sat</sub> 2: Peak current for approximately 20% rolloff @ +125°C

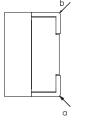
- 6. K-factor: Used to determine  $B_{p,p}$  for core loss (see graph).  $B_{p,p} = K * L * \Delta I * 10^3. B_{p,p}$  (Gauss), K: (K-factor from table), L: (Inductance in nH),  $\Delta I$  (Peak-to-peak ripple current in Amps).
- 7. Part Number Definition: FP1007Rx-Rxx-R FP1007R= Product code and size
  - x = DCR indicator

 $Rxx = Inductance value in \mu H$ , R = decimal point

-R suffix = RoHS compliant



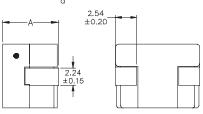




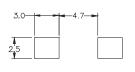
A FP1007R1= 6,80±0,2

FP1007R2= 6.30±0.2

FP1007R3= 7.30±0.2



# Recommended Pad Layout





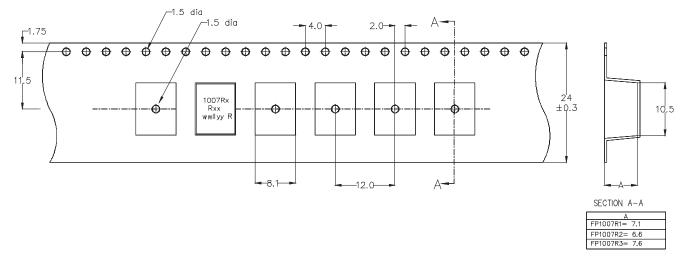


Part marking: 1007Rx (x = DCR indicator), Rxx (xx = inductance value in uH, R = decimal point, wwllyy = date code, R = revision level Tolerances are  $\pm 0.25$  millimeters unless stated otherwise. PCB tolerances are  $\pm 0.1$  millimeters unless stated otherwise All soldering surfaces to be coplanar within 0.1 millimeter DCR measured from point "a" to point "b" Do not route traces or vias underneath the inductor

### Packaging information (mm)

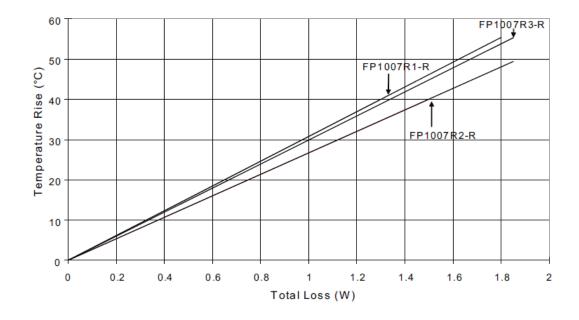
Supplied in tape and reel packaging, FP1007R1 700 parts per 13 " diameter reel FP1007R2 750 parts per 13 " diameter reel

FP1007R3 650 parts per 13 " diameter reel

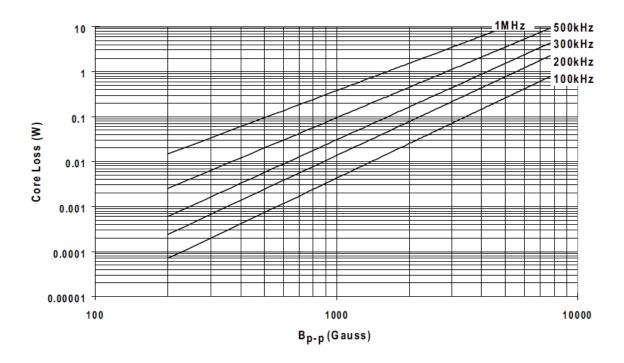


User direction of feed —

## Temperature rise vs. total loss

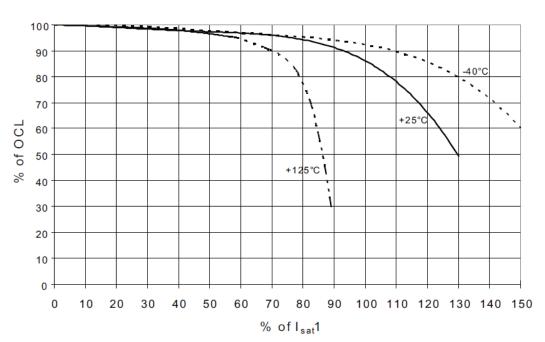


# Core loss vs. B<sub>p-p</sub>



## **Inductance characteristics**





### Solder reflow profile

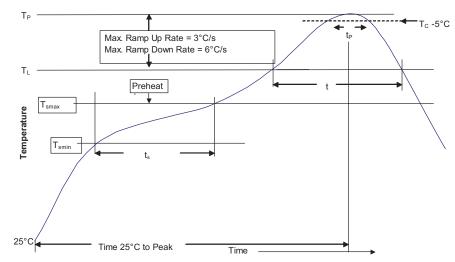


Table 1 - Standard SnPb Solder (T<sub>C</sub>)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5mm)	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T<sub>C</sub>)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

#### **Reference JDEC J-STD-020D**

older	
30 Seconds**	
8 Minutes Max.	

 $<sup>^{*}</sup>$  Tolerance for peak profile temperature (T $_{\rm p}$ ) is defined as a supplier minimum and a user maximum.

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<sup>\*\*</sup> Tolerance for time at peak profile temperature (t<sub>p</sub>) is defined as a supplier minimum and a user maximum.